

INFORMATION DISCLOSURE STATEMENT

Applicant : Takahashi et al.
App. No : 10/580,065
Filed : May 29, 2007
For : CHEMICALLY AMPLIFIED POSITIVE
PHOTOSENSITIVE THERMOSETTING RESIN
COMPOSITION, METHOD OF FORMING
CURED ARTICLE, AND METHOD OF
PRODUCING FUNCTIONAL DEVICE
Examiner : Hamilton, Cynthia
Art Unit : 1795
Conf No. : 3534

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified application is a PTO/SB/08 Equivalent listing 3 (three) references, of which 2 (two) are enclosed/submitted.

This Information Disclosure Statement is being filed after the mailing date of a final action or after the mailing date of a Notice of Allowance. This Statement is accompanied by the fee set forth in 37 C.F.R. § 1.17(p). The Commissioner is hereby authorized to charge any additional fees which may be required or to credit any overpayment to Account No. 11-1410.

CERTIFICATION UNDER 37 C.F.R. § 1.97(c)(1)

I hereby certify that each item of information contained in this Statement was first cited in any communication from a foreign Patent Office in a counterpart foreign application not more than 30 days prior to the filing of this Information Disclosure Statement.

Respectfully submitted,

KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: October 5, 2010

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